

# Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that: **JUL 22 2002**

My residence, post office address and citizenship \_\_\_\_\_ as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention **entitled**  
(Insert Title) **LOW-TEMPERATURE CURING, FAVORABLE FEEL COATING COMPOSITION**

the specification of which is attached hereto unless the following is checked:



was filed on \_\_\_\_\_ as United States Application Number or PCT International  
Application Number \_\_\_\_\_ and was amended on \_\_\_\_\_  
(if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claim(s), as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 (a) - (d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

(List prior foreign applications. See note A on back of this page)	2001-20104 (Number)	Japan (Country)	29/01/2001 (Day/Month/Year Filed)	Priority Claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	2001-348449 (Number)	Japan (Country)	14/11/2001 (Day/Month/Year Filed)	<input checked="" type="checkbox"/> Yes <input type="checkbox"/> No
	(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No
	(Number)	(Country)	(Day/Month/Year Filed)	<input type="checkbox"/> Yes <input type="checkbox"/> No

(See note B on back of this page)

☐ See attached list for additional prior foreign applications

I hereby claim the benefit under Title 35, United States Code, § 119(e) of any United States provisional application(s) listed below.

_____ (Application Number)	_____ (Filing Date)
_____ (Application Number)	_____ (Filing Date)

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of the application:

(List Prior U.S. Applications)	_____ (Application Serial Number)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)
	_____ (Application Serial Number)	_____ (Filing Date)	_____ (Status) (patented, pending, abandoned)

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

James E. Armstrong, III, Reg. No. 18,366; William F. Westerman, Reg. No. 29,988; Ken-Ichi Hattori, Reg. No. 32,861; Le-Nhung McLeland, Reg. No. 31,541; Ronald F. Naughton, Reg. No. 24,616; John R. Pegan, Reg. No. 18,069; William G. Kratz, Jr., Reg. No. 22,631; Albert Tockman, Reg. No. 19,722; Mel R. Quintos, Reg. No. 31,898; Donald W. Hanson, Reg. No. 27,133; Stephen G. Adrian, Reg. No. 32,878; William L. Brooks, Reg. No. 34,129; John F. Carney, Reg. No. 20,276; Edward F. Welsh, Reg. No. 22,455; Patrick D. Muir, Reg. No. 37,403; Gay A. Spahn, Reg. No. 34,978; and John P. Kong, Reg. No. 40,054.

Please direct all communications to the following address:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full name of sole or first inventor (given name, family name) Takashi KITA

(See note  
C above)

Inventor's Signature Takashi Kita Date January 16, 2002

Residence Kume-gun, Okayama-ken, Japan Citizenship Japan

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Full name of second inventor (given name, family name) Hiroyuki ARIMOTO

Inventor's Signature Hiroyuki Arimoto Date January 16, 2002

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Full name of third inventor (given name, family name) Osamu SHOJI

Inventor's Signature Osamu Shoji Date January 16, 2002

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Full name of fourth inventor (given name, family name) Takayuki KISHIMOTO

Inventor's Signature Takayuki Kishimoto Date January 16, 2002

Residence Tsuyama-shi, Okayama-ken, Japan Citizenship Japan

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Full name of fifth inventor (given name, family name) Kenji KAWAZU

Inventor's Signature Kenji Kawazu Date January 16, 2002

Residence Nagoya-shi, Aichi-ken, Japan Citizenship Japan

Post Office Address c/o TOYOTA JIDOSHA KABUSHIKI KAISHA, 1, Toyota-cho, Toyota-shi, Aichi-ken, Japan

Full name of sixth inventor (given name, family name) Mika KAI

Inventor's Signature Mika Kai Date January 16, 2002

Residence Toyota-shi, Aichi-ken, Japan Citizenship Japan

Post Office Address c/o TOYOTA JIDOSHA KABUSHIKI KAISHA, 1, Toyota-cho, Toyota-shi, Aichi-ken, Japan

Full name of seventh inventor (given name, family name) \_\_\_\_\_

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence \_\_\_\_\_ Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_

Full name of eighth inventor (given name, family name) \_\_\_\_\_

Inventor's Signature \_\_\_\_\_ Date \_\_\_\_\_

Residence \_\_\_\_\_ Citizenship \_\_\_\_\_

Post Office Address \_\_\_\_\_

## U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by  
 1) CHASHI CHEMICAL INDUSTRIES LTD., of 40, Taiheidai, Shoo-cho, Katsuta-gun, Okayama-ken, Japan; and 2) TOMOTA JIDOSHA KAKUSHIKI KAISHA, of 1, Toyota-cho, Toyota-shi, Aichi-ken, Japan

(Insert ASSIGNEE's  
Name(s) Address(es))

(hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of Invention)

LOW-TEMPERATURE CURING, FAVORABLE FEEL COATING COMPOSITION

(\*If the assignment is  
being filed after the filing  
of the application, this  
section must be  
completed)

for which application for Letters Patent of the United States was executed on even date herewith unless otherwise indicated below:

"filed on \_\_\_\_\_, Serial No. \_\_\_\_\_  
 (Armstrong, Westerman, Hattori, McLeland & Naughton is hereby authorized to insert the series code, serial number and/or filing date hereon, when known)

and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.

The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.

The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

<u>Takashi Kita</u> (SIGNATURE)	Takashi KITA (TYPE NAME)	January 16, 2002 (DATE)
<u>Hiroyuki Arimoto</u> (SIGNATURE)	Hiroyuki ARIMOTO (TYPE NAME)	January 16, 2002 (DATE)
<u>Osamu Shoji</u> (SIGNATURE)	Osamu SHOJI (TYPE NAME)	January 16, 2002 (DATE)
<u>Takayuki Kishimoto</u> (SIGNATURE)	Takayuki KISHIMOTO (TYPE NAME)	January 16, 2002 (DATE)
<u>Kenji Kawazu</u> (SIGNATURE)	Kenji KAWAZU (TYPE NAME)	January 16, 2002 (DATE)
<u>Mika Kai</u> (SIGNATURE)	Mika KAI (TYPE NAME)	January 16, 2002 (DATE)
_____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)

NO LEGALIZATION REQUIRED